

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant	:	Park <i>et al.</i>
Appl. No.	:	10/500,494
Filed	:	December 27, 2004
For	:	METHOD OF FORMING COPPER INTERCONNECTIONS FOR SEMICONDUCTOR INTEGRATED CIRCUITS ON A SUBSTRATE
Examiner	:	Thanh V. Pham
Group Art Unit	:	2823

AMENDMENT AND REQUEST FOR CONTINUED EXAMINATION

Mail Stop RCE

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir:

In response to the Advisory Action mailed on January 24, 2007, please amend the above-captioned application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 4 of this paper.